



SBR1A40S1

1A SBR SUPER BARRIER RECTIFIER

Features

- Low Forward Voltage Drop
- Low Reverse Leakage
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology (SBR[®])
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.
- https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SOD123
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Leads: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208@3
- · Polarity: Cathode Band
- Weight: 0.004 grams (Approximate)

SOD123



Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
SBR1A40S1-7	SOD123	3,000/Tape & Reel

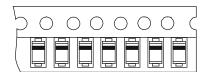
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



<u>D</u> 4 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: G = 2019)
 M = Month (ex: 9 = September)



Date Code Key

Year	2004	~	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
Code	R	~	С	D	Е	F	G	Н	ı	J	K	L	М	N
Mont	h	Jan	Feb	Mar	Apr	May	Jun	Jul	A	ıg	Sep	Oct	Nov	Dec
														_



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derating current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	٧
Average Rectified Output Current $T_C = +65^{\circ}C$	lo	1	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	20	А

Thermal Characteristics

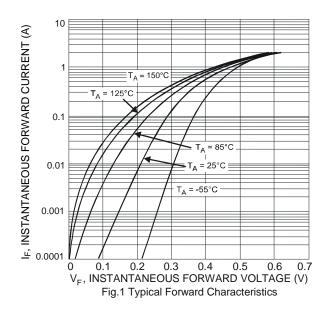
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Thermal Resistance Junction to Ambient (Note 5) Thermal Resistance Junction to Ambient (Note 6) Thermal Resistance Junction to Case (Note 5) Thermal Resistance Junction to Case (Note 6)	R ₀ JA R ₀ JA R ₀ JC R ₀ JC	473 407 90 80	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C
Power Dissipation (Note 6)	P _D	320	mW

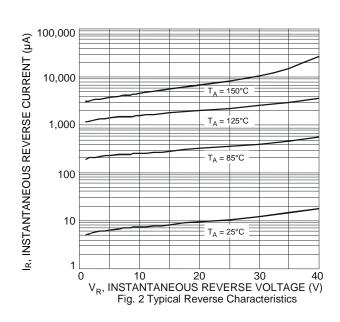
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V	_	_	0.52	- V	I _F = 1A, T _J = +25°C
Forward Vollage Drop	V _F	_	0.44	0.50		I _F = 1A, T _J = +125°C
Leakage Current (Note 7)	1	_	18	200	μΑ	$V_R = 40V, T_J = +25^{\circ}C$
Leakage Current (Note 7)	IR	_	4	_	mA	$V_{R} = 40V$. $T_{L} = +100$ °C

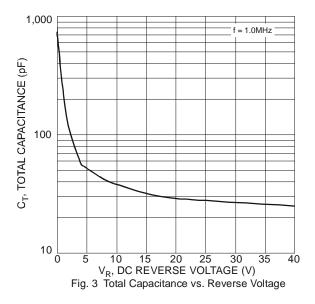
Notes:

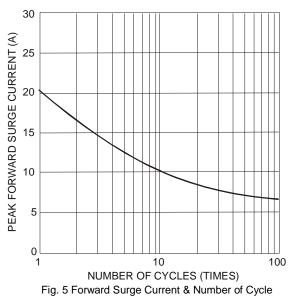
- 5. FR-4 PCB, 2 oz. copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
- Device mounted on FR-4 substrate, 1" x 1", 2oz, copper, single-sided, PC boards.
 Short duration pulse test used to minimize self-heating effect.

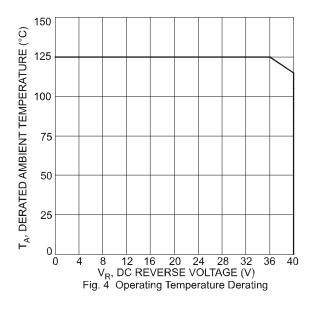


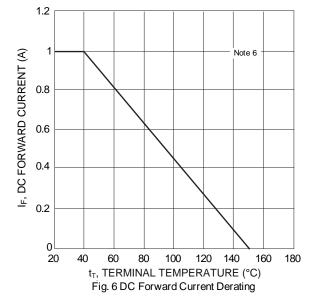










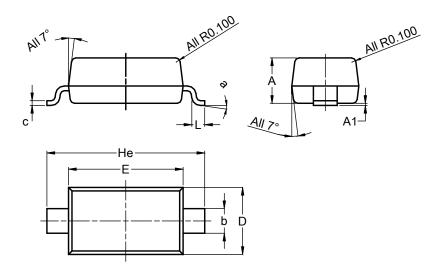




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123

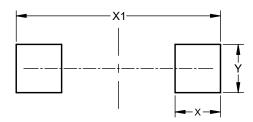


SOD123						
Dim	Min	Max	Тур			
Α	1.00	1.35	1.05			
A1	0.00	0.10	0.05			
b	0.52	0.62	0.57			
С	0.10	0.15	0.11			
D	1.40	1.70	1.55			
Е	2.55	2.85	2.65			
He	3.55	3.85	3.65			
L	0.25	0.40	0.30			
а	00	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOD123



Dimensions	Value (in mm)
Х	0.900
X1	4.050
Υ	0.950



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